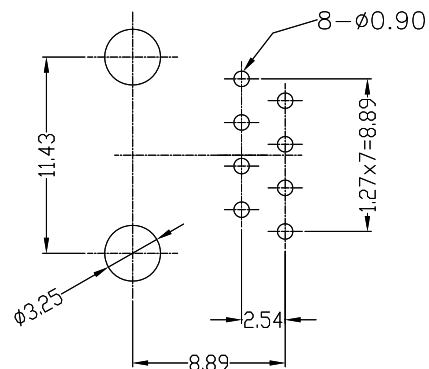
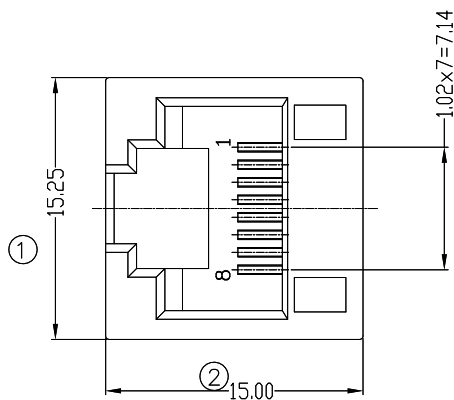
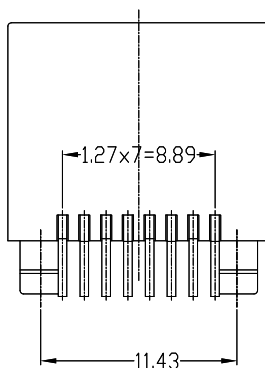
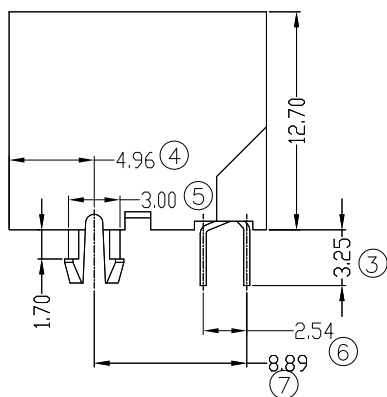


RoHS compliant



PCB LAYOUT/TOP VIEW



NOTES

MATERIAL

1. HOUSING MATERIAL : HIGH TEMP THERMOPLASTIC
FLAMMABILITY RATING UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE T=0.3mm.
3. PLATING : GOLD LATING OVER NICKEL IN CONTACT
TIN PLATING OVER NICKEL IN SOLDER AREA.
: FU", 3U", 6U", 15U", 30", 50".

ELECTRICAL

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 40 MILLIOHMS MAX.
4. INSULATION RESISTANCE : 1000 MEGOHMS MIN @ 500V DC .
5. DIELECTRIC RESISTANCE : 1000V AC RMS 50Hz. 1MIN.

MECHANICAL

1. DURRABILITY : 750 CYCLES MIN.
2. PCB RETENTIONPRE-SOLDER : 1 LB MIN.

ENVIRONMENTAL:

1. STORAGE : -40℃~+85℃.
2. OPERATION : -40℃ TO 85℃.

Mates With Modular Plug Conforming To FCC Part 68, Subpart F.

黑壳红基座:

6u" P/N RJ52F-8811-002511H

15u" P/N RJ52F-8811-002611H

30u" P/N RJ52F-8811-002711H

50u" P/N RJ52F-8811-002811H

黄壳红基座:

6u" P/N RJ52F-8811-002514H

					GENERAL TOLERANCE		DRAWN		Gene Li		2018/11/21		X-SHUN 东莞市祥舜电子科技有限公司 DONGGUAN X-SHUN ELECTRONIC TECHNOLOGY CO., LTD					
					.X	±0.35	X.°	± 2°	CHECKE		Hc							
					.XX	±0.25	.X°	± 1°	APPROVE				PART NO.		RJ52F-8811-002511H			
A0		NEW DESIGN		2018/11/21		.XXX	±0.15	.XX°	± 0.5°					TITLE:		RJ45 8P8C 180° H=12.7mm PCB JACK		
REV	ECN NO	DESCRIPTION		DATE	SIGNATURE	PROJECT		UNIT		mm	SCALE	1:1	SHEET	1/1	REV	A0	DRAWING NO.	RJ52F-88
																		